Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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NPN SILICON RF TRANSISTOR **2SC4093**

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 4-PIN MINIMOLD

DESCRIPTION

The 2SC4093 is an NPN silicon epitaxial transistor designed for low noise amplifier at VHF, UHF and CATV band.

It has large dynamic range and good current characteristics, and is contained in a 4-pin minimold package which enables high-isolation gain.

FEATURES

- Low Noise NF = 1.1 dB TYP. @ Vce = 10 V, Ic = 7 mA, f = 1 GHz
- High Power gain
 |S_{21e}|² = 13 dB TYP. @ Vce = 10 V, Ic = 20 mA, f = 1 GHz
- Maximum available power gain: MAG = 14.2 dB TYP. @ VcE = 10 V, Ic = 20 mA, f = 1 GHz
- 4-pin minimold Package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form
2SC4093	50 pcs (Non reel)	• 8 mm wide embossed taping
2SC4093-T1	3 kpcs/reel	Pin 3 (Base), Pin 4 (Emitter) face to perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office. The unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vсво	20	V
Collector to Emitter Voltage	Vceo	12	V
Emitter to Base Voltage	Vebo	3.0	V
Collector Current	lc	100	mA
Total Power Dissipation	Ptot Note	200	mW
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	–65 to +150	°C

Note Free air

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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ELECTRICAL CHARACTERISTICS (TA = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit	
DC Characteristics							
Collector Cut-off Current	Ісво	Vсв = 10 V, IE = 0 mA	-	-	1.0	μA	
Emitter Cut-off Current	Іево	V _{EB} = 1 V, Ic = 0 mA	-	-	1.0	μA	
DC Current Gain	hfe Note 1	Vce = 10 V, Ic = 20 mA	50	120	250	-	
RF Characteristics							
Gain Bandwidth Product	f⊤	Vce = 10 V, Ic = 20 mA	-	7.0	-	GHz	
Insertion Power Gain	S _{21e} ²	Vce = 10 V, Ic = 20 mA, f = 1.0 GHz	11	13	-	dB	
Noise Figure	NF	Vce = 10 V, Ic = 7 mA, f = 1.0 GHz	-	1.1	2.0	dB	
Reverse Transfer Capacitance	Cre ^{Note 2}	Vсв = 10 V, IE = 0 mA, f = 1.0 MHz	-	0.6	0.95	pF	

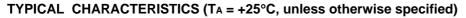
Notes 1. Pulse measurement: PW \leq 350 μ s, Duty Cycle \leq 2%

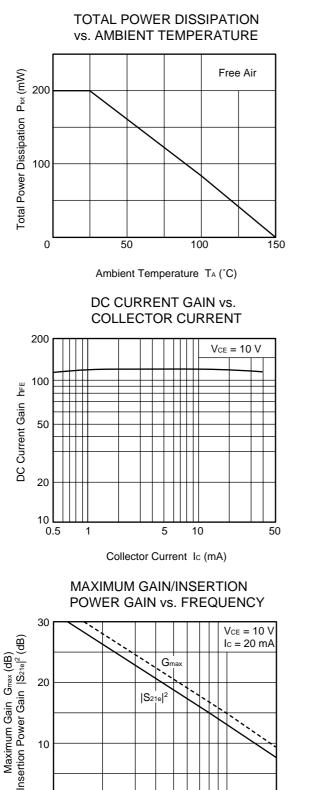
2. Collector to base capacitance when the emitter grounded

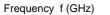
hfe CLASSIFICATION

Rank	R26/RBF ^{Note}	R27/RBG ^{Note}	R28/RBH ^{Note}	
Marking	R26	R27	R28	
Range	50 to 100	80 to 160	125 to 250	

Note Old Specification / New Specification



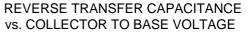


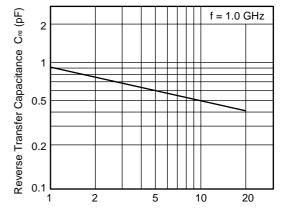


0.5

1.0

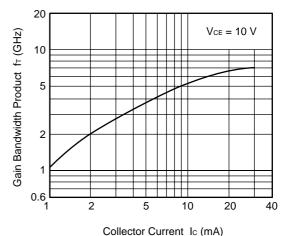
2.0



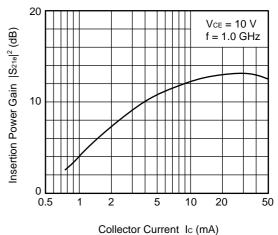


Collector to Base Voltage VCB (V)

GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT



INSERTION POWER GAIN vs. COLLECTOR CURRENT

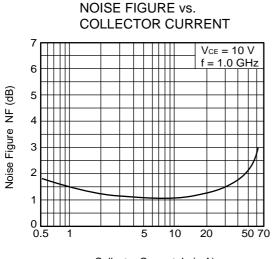


Remark The graphs indicate nominal characteristics.

0

0.1

0.2



Collector Current Ic (mA)

Remark The graph indicates nominal characteristics.

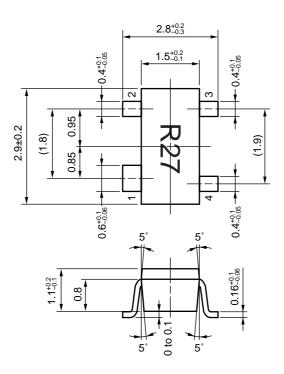
★ S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

- Click here to download S-parameters.
- $[\mathsf{RF} \text{ and Microwave}] \rightarrow [\mathsf{Device Parameters}]$
- URL http://www.ncsd.necel.com/

★ PACKAGE DIMENSIONS

4-PIN MINIMOLD PACKAGE (UNIT: mm)



PIN CONNECTIONS

- 1. Collector
- 2. Emitter
- 3. Base
- 4. Emitter

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